## 504247017 02/27/2017

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

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## **RECEIVING PARTY DATA**

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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15443687

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ATTORNEY DOCKET NUMBER:	TELF-0104-02S01US
NAME OF SUBMITTER:	NING LI
SIGNATURE:	/Ning Li/
DATE SIGNED:	02/27/2017
	This document serves as an Oath/Declaration (37 CFR 1.63).

PATENT REEL: 041386 FRAME: 0494

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## **Total Attachments: 4**

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PATENT REEL: 041386 FRAME: 0495

## ASSIGNMENT AND DECLARATION FOR PATENT APPLICATION

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the undersigned, who have created a certain invention for which an application for United States Letters Patent is entitled:

#### SUBSTRATE PROCESSING METHOD AND RECORDING MEDIUM

as described and claimed in the specification identified by the above Attorney Docket No. do hereby sell, assign and transfer to TOKYO ELECTRON LIMITED, a corporation of Japan, having a place of business at 3-1 Akasaka 5-chome, Minato-ku, Tokyo 107-6325, Japan, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

Agree that TOKYO ELECTRON LIMITED, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

This application was made or was authorized to be made by me.

I acknowledge the duty to disclose to the U. S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate or \$365(a) of any PCT International application(s) which

design	ated at least one country other than the United States, listed below and have also identified below any
	application for patent or inventor's certificate, or PCT International application, having a filing date that of the application on which priority is claimed.
	No such Applications have been filed.
	Such Applications have been filed as follows:

Customer No. 36872 Page 1

Atto	rney Docket No.:			
<u>Pri</u>	or Foreign Application(s) Application Number	Country	Day/Month/Year Filed	Priority Claimed Yes <u>No</u>
	2016-036013	Japan	26/02/2016	
	eby claim the benefit under Title 3 cation(s) listed below.	5, United States	Code §119(e) of any United	States provisional
$\boxtimes$	No such Applications have been fil	ed.		
	Such Applications have been filed	as follows:		
á	Provisional Application(s) Application Number	<u>Prior</u>	ity Claimed Under 35 USC 119 Day/Month/Year Filed	<u>(e)</u>
belov Unite ackno defin	eby claim the benefit under Title 35, we and, insofar as the subject matter of the distance application in the manner proposed the duty to disclose to the Open of Title 37, Code of Federal Regulation(s) and the national or PCT interests.	f each of the claim wided by the first p ffice all informational slations, §1.56 wh	ns of this application is not dis paragraph of Title 35, United S on known to me to be material ich occurred between the filing	closed in the prior tates Code, §112, I to patentability as
$\boxtimes$	No such Applications have been fil	led.		
	Such Applications have been filed	as follows:		
	Application Serial No.	Filing Date	Status (Patented, Pe	ending, Abandoned)
made to be like s State issue	eby declare that I have reviewed and herein of my own knowledge are true true; and further that these statements so made are punishable by fine or im a Code and that such willful false stated thereon.	e and that all staten were made with the prisonment, or bo	nents made on information and he knowledge that willful false th, under Section 1001 of Title	belief are believed statements and the e 18 of the United
Full	Name of Sole/First Inventor:			
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Inve	entor's Signature:		Date: Month/Day/Ye	
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Citi	zenship:			
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Customer No. 36872

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Customer No. 36872

**RECORDED: 02/27/2017** 

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